PATENT ASSIGNMENT

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tadahiro Tagawa	03/03/2010

RECEIVING PARTY DATA

Name:	SOLAR WORLD INTERNATIONAL CO., LTD.	
Street Address:	1-27, Kandanishikicho	
City:	Chiyoda-ku, Tokyo	
State/Country:	Japan	
Postal Code:	101-0054	

PROPERTY NUMBERS Total: 4

Property Type	Number
Patent Number:	6655814
Patent Number:	D459005
Patent Number:	D446586
Patent Number:	D493197

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Lee Cheng

Total Attachments: 2

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PATENT

REEL: 024079 FRAME: 0750

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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned assignee TADAHIRO TAGAWA, does hereby assign, sell and transfer unto:

SOLAR WORLD INTERNATIONAL CO., LTD., of the address

1-27, Kandanishikicho, Chiyoda-ku, Tokyo 101-0054 JAPAN

(hereinafter ASSIGNEE), its successors, assigns, and legal representatives, 100% of its right, title and interest for the United States, and countries foreign thereto, in and to the inventions relating to

U.S. Patent No. 6,655,814 Entitled: LIGHT EMITTING BLOCK

(assignment recorded at Reel 012988, Frame 0281)

U.S. Patent No. D459,005 Entitled: LIGHT EMITTING TILE

(assignment recorded at Reel 010620, Frame 0807)

U.S. Patent No. D446,586 Entitled: LIGHT EMITTING TILE

(assignment recorded at Reel 010620, Frame 0809)

U.S. Patent No. D493,197 Entitled: WALL INDICATOR

(no assignment recorded)

and in and to said patents and patent applications, including any divisions and continuations thereof, and in and to any and all Letters Patents of the United States, and countries foreign thereto, which may be granted for said inventions, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patents

And, the undersigned warrants and covenants that it is an assignee of these patents and patent applications and has the full and unencumbered right to sell and assign 100% of its interests herein and that it has not executed and will not execute any document or instrument in conflict herewith;

And, the undersigned further covenants and agrees that at any time upon request of said ASSIGNEE, its successors, legal representatives or assigns he will communicate to said

PATENT REEL: 024079 FRAME: 0751 ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said inventions or patent applications and that he will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said inventions, to said applications including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention.

ASSIGNOR

RECORDED: 03/16/2010

TADAHIRO TAGAWA,

201, 10-9, Higashiimajyuku 3-chome Himeji-city, Hyogo 670-0056 JAPAN

Tadahira Tanawa

March 3, 2010

(Date)

Tadahiro Tagawa Inventor

> PATENT REEL: 024079 FRAME: 0752